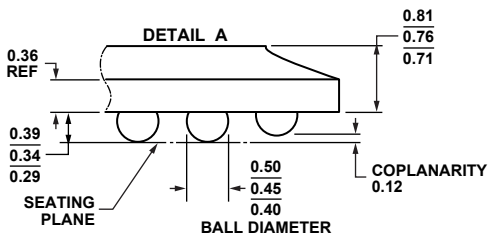
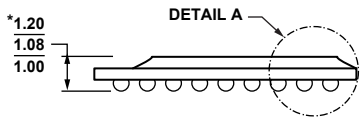
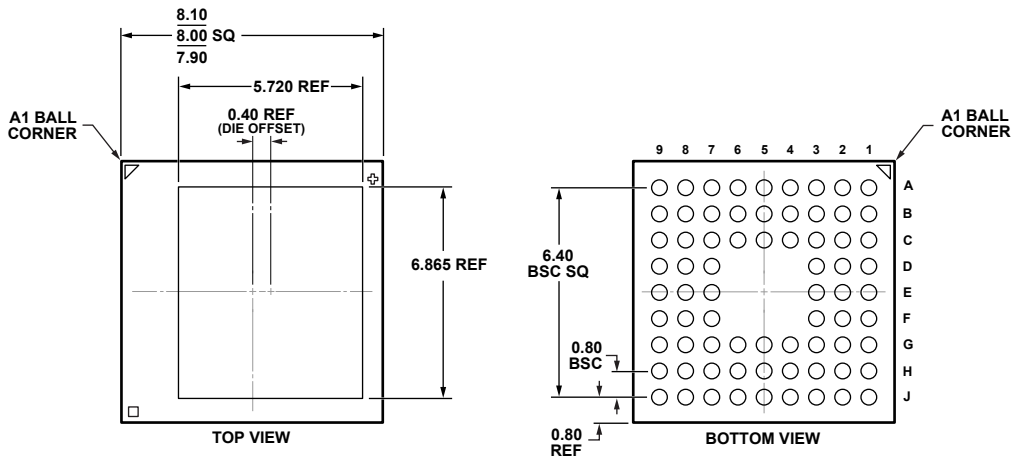


**72-Ball Chip Scale Package Ball Grid Array [CSP\_BGA]  
(BC-72-2)**

Dimensions shown in millimeters



\*COMPLIANT TO JEDEC STANDARDS MO-225 WITH  
EXCEPTION TO PACKAGE HEIGHT.